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(12) **United States Design Patent**
Lu

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(54) **BONE CONDUCTION HEADPHONES**

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(72) Inventor: **Haijun Lu**, Sichuan (CN)

(**) Term: **15 Years**

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(30) **Foreign Application Priority Data**

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(51) **LOC (11) Cl.** **14-01**

(52) **U.S. Cl.**
USPC **D14/205**

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128/865, 866, 867; 181/129, 130, 135;
379/430, 431; 381/380, 381, 370, 374,
381/74, 151, 326, 378, 379; 455/90.3,
455/575.1, 569.1
CPC H04R 1/1066; H04R 1/1016; H04R 5/033;
H04R 5/0335; H04R 1/10; H04R 25/00;
H04R 25/02
See application file for complete search history.

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Primary Examiner — Paula Allen Greene

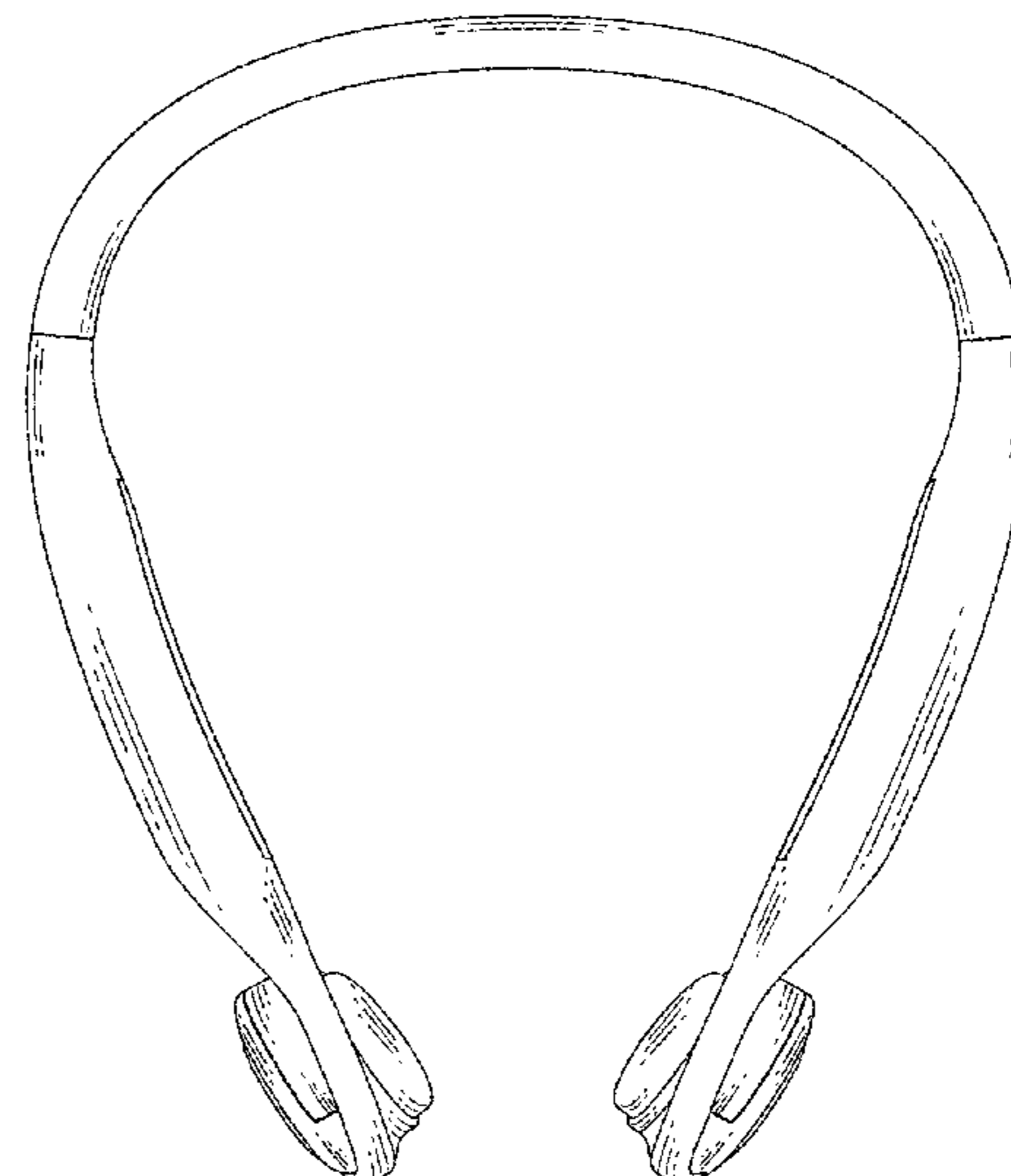
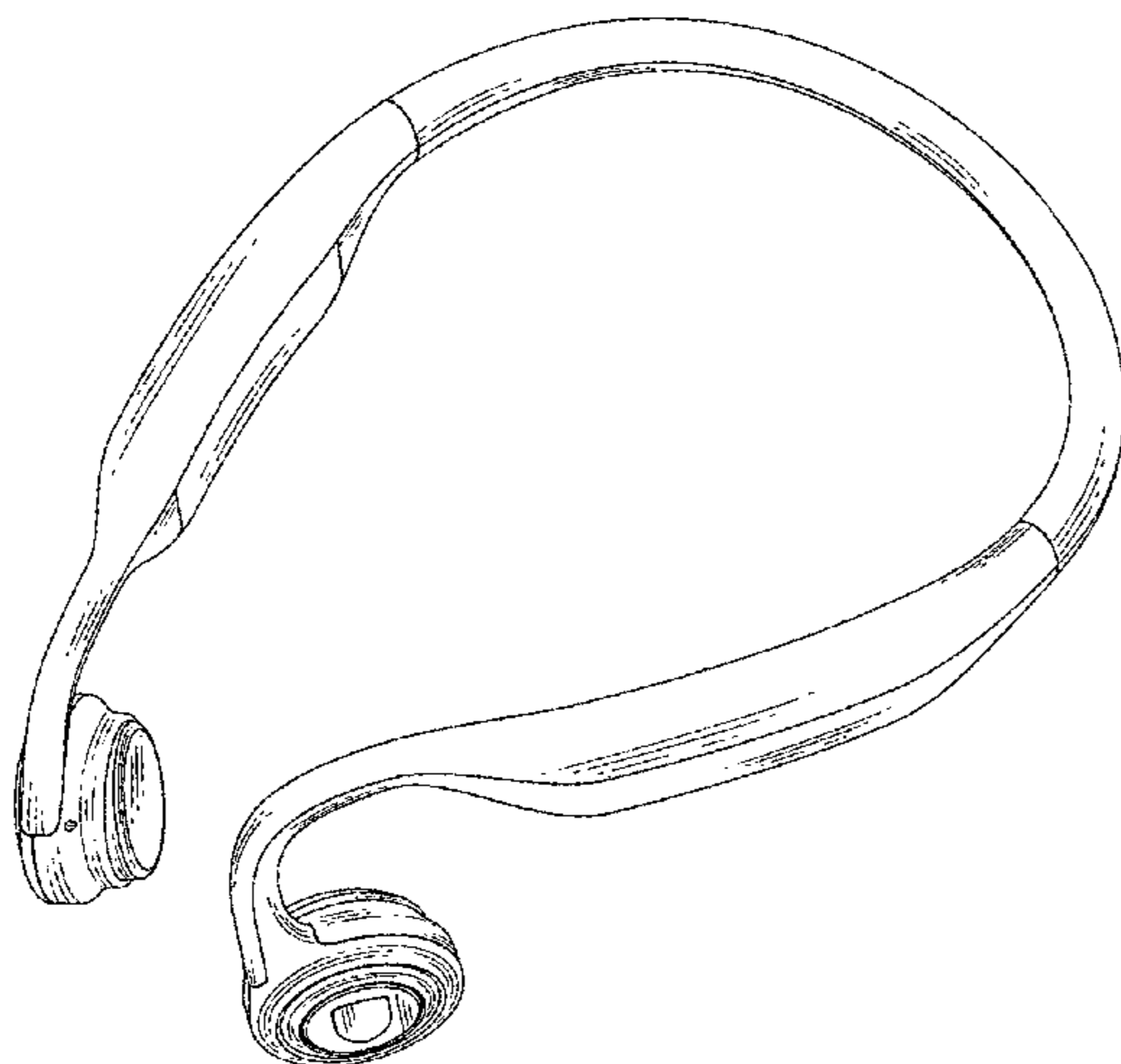
(57) **CLAIM**

The ornamental design for bone conduction headphones, as shown and described.

DESCRIPTION

FIG. 1 is a perspective view of bone conduction headphones showing my new design;
FIG. 2 is a front elevational view thereof;
FIG. 3 is a rear elevational view thereof;
FIG. 4 is a left side elevational view thereof;
FIG. 5 is a right side elevational view thereof;
FIG. 6 is a top plan view thereof;
FIG. 7 is a bottom plan view thereof; and,
FIG. 8 is another perspective view thereof.
The broken lines depict environment that forms no part of the claimed design.

1 Claim, 8 Drawing Sheets



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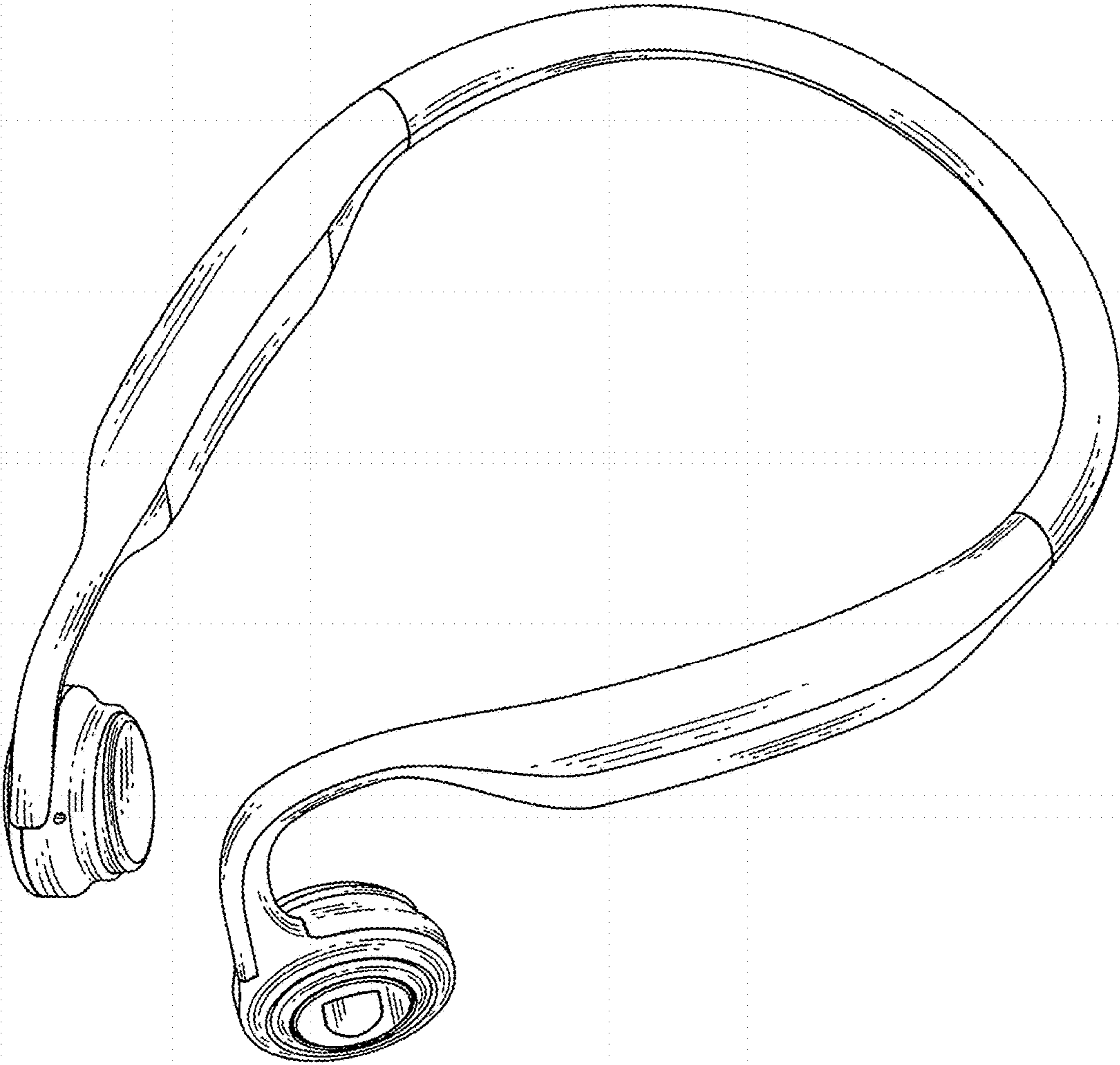


FIG. 1

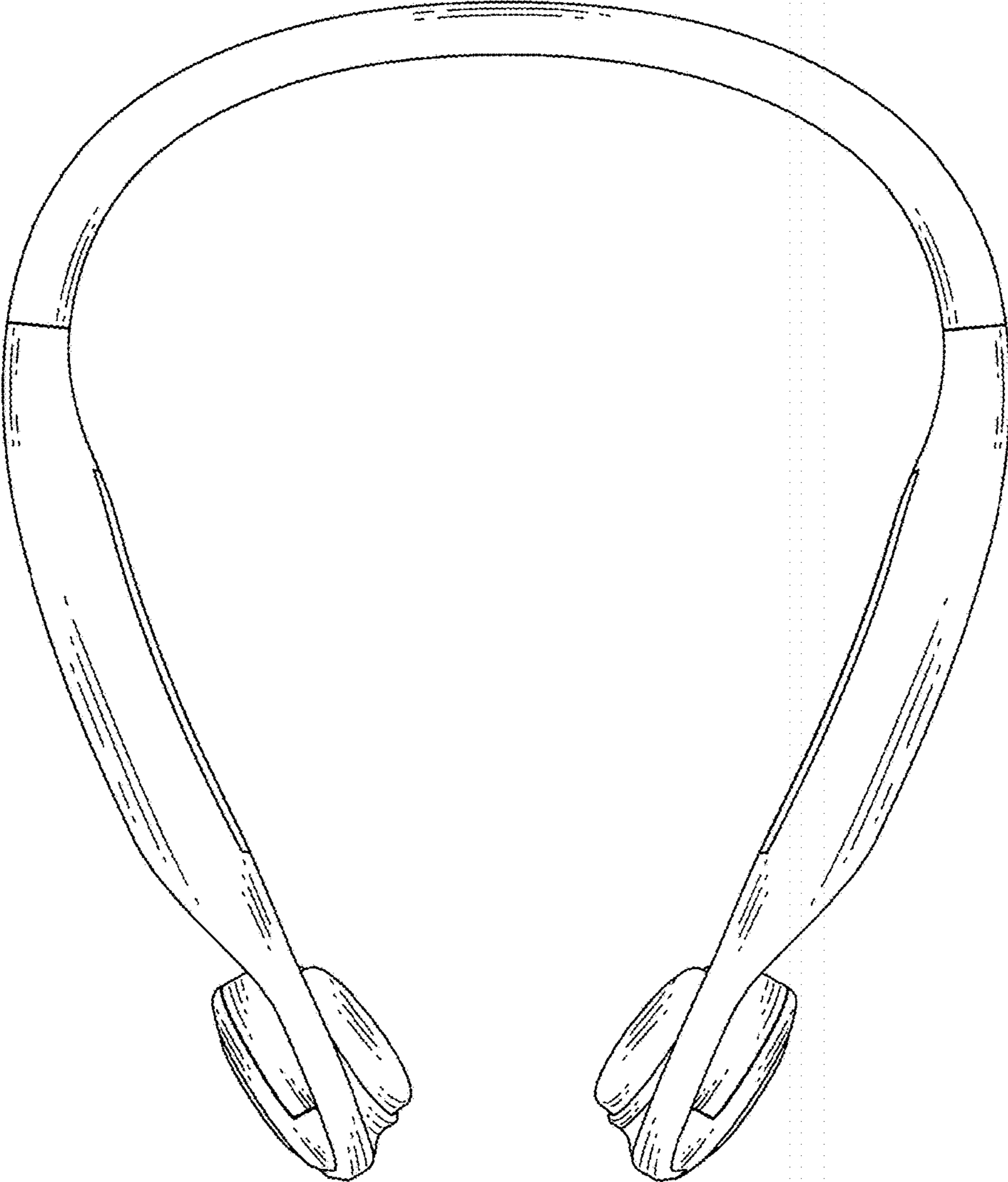


FIG.2

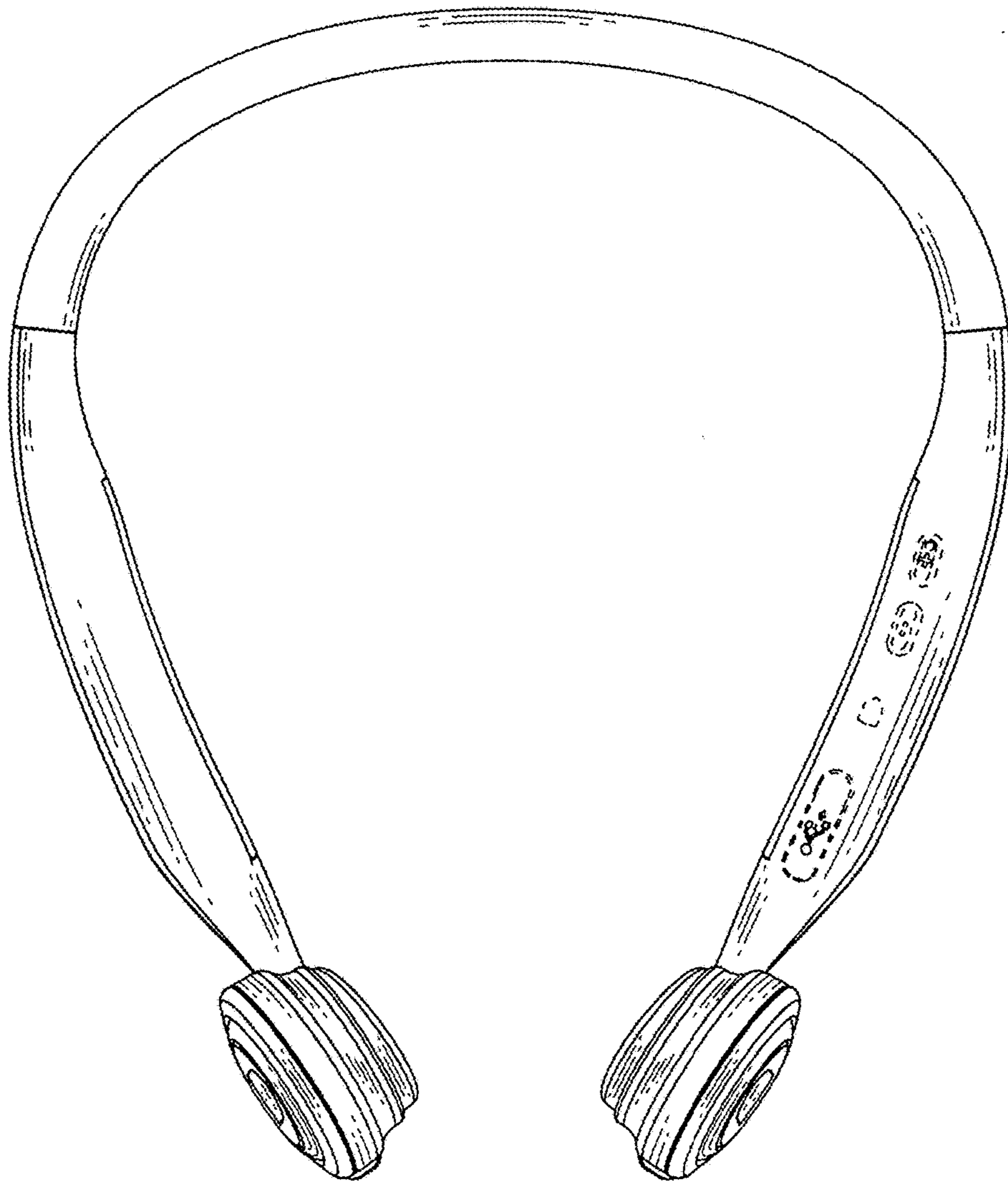


FIG.3

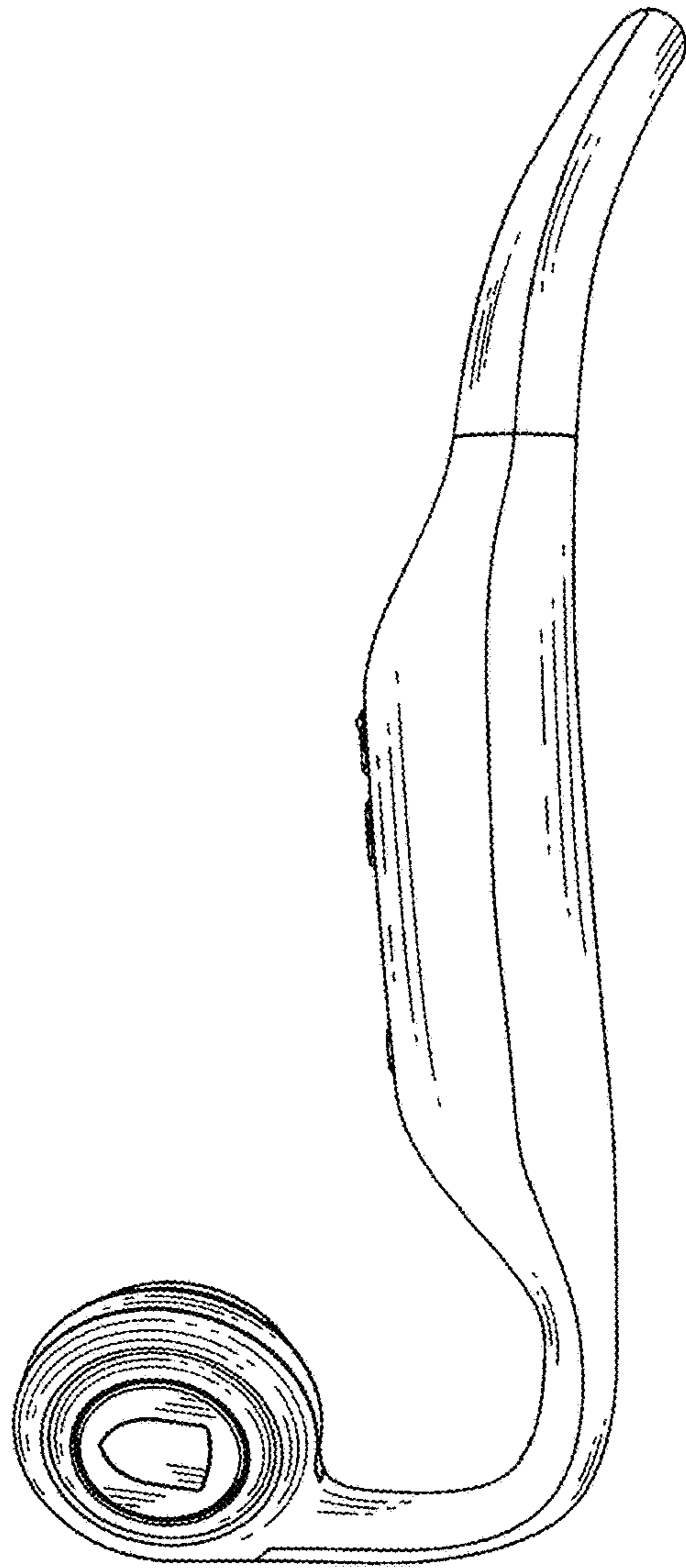


FIG. 4

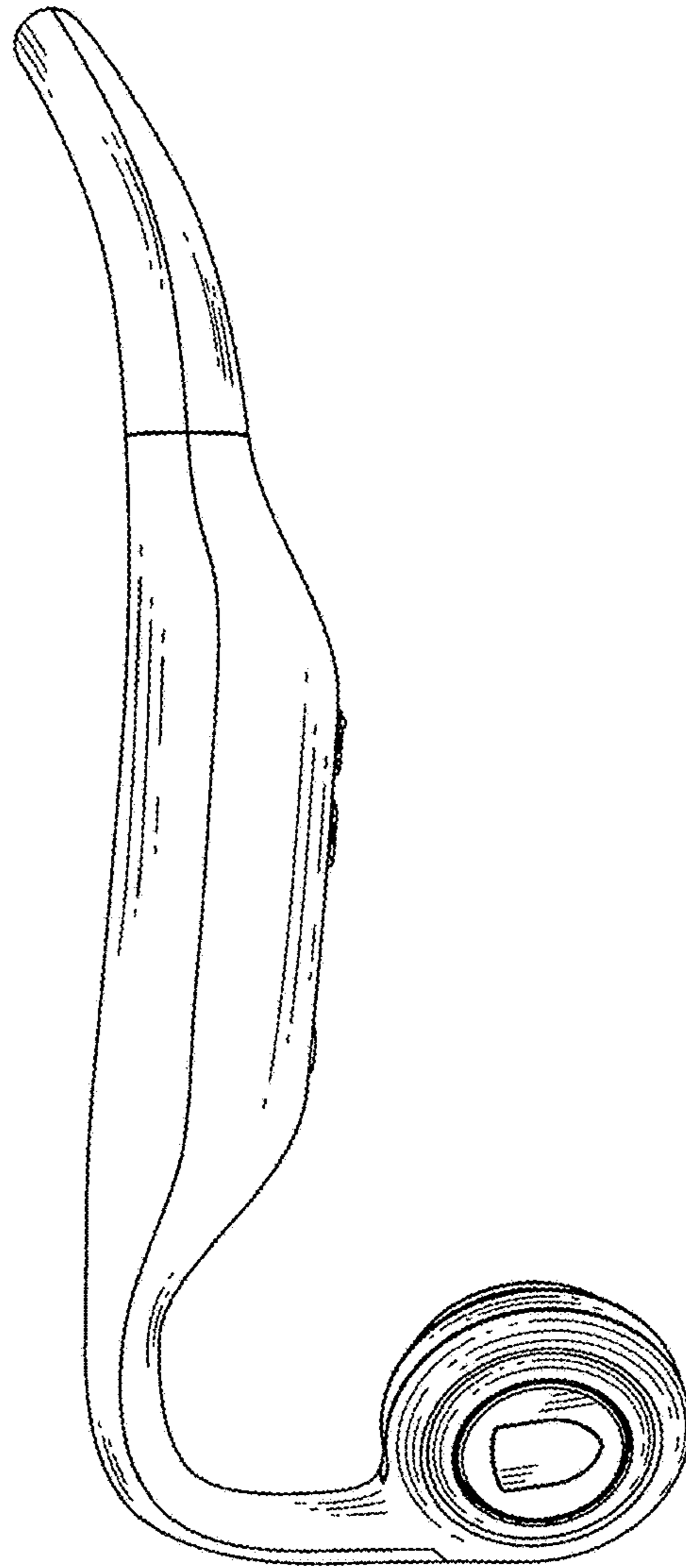


FIG. 5

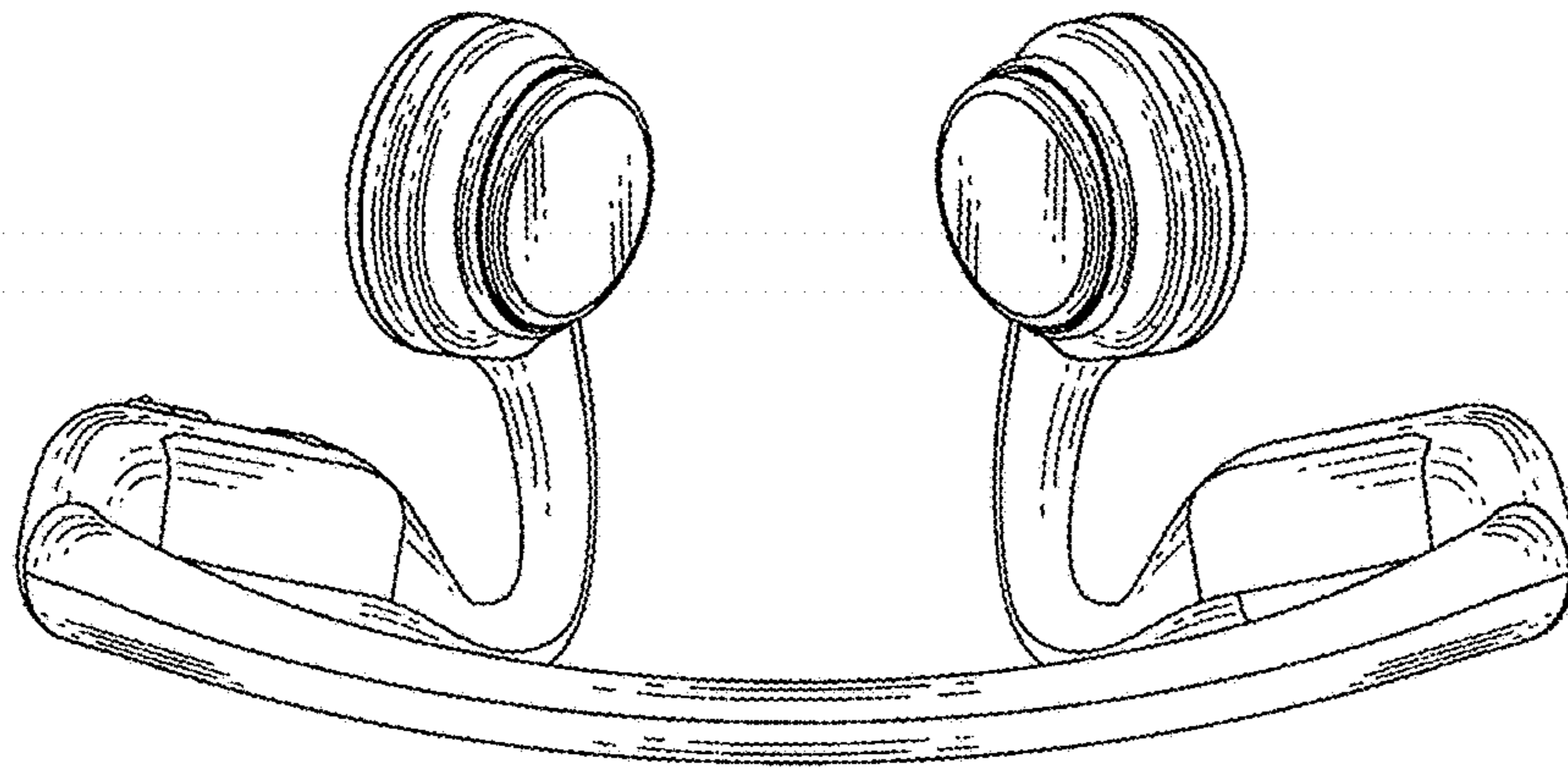


FIG.6

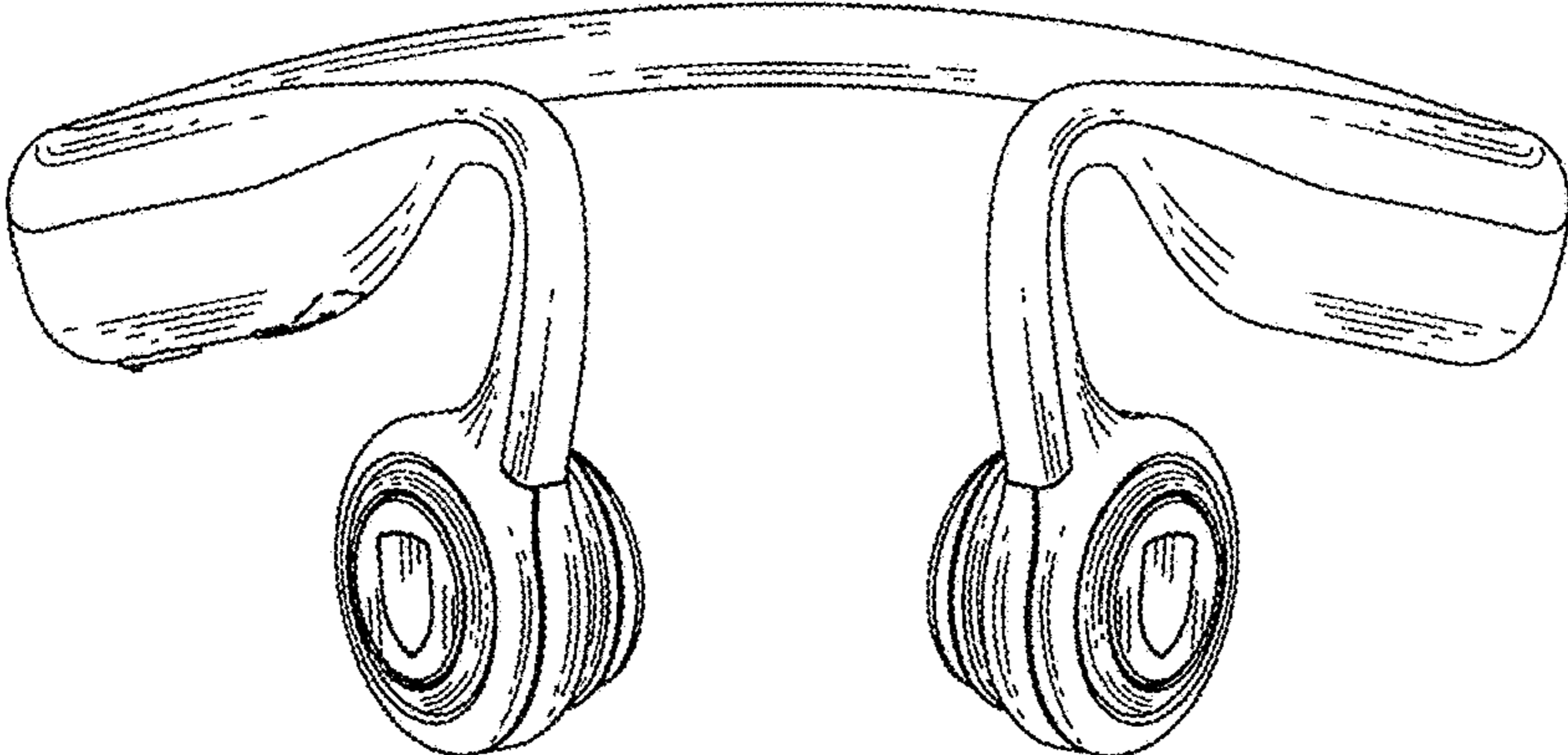


FIG. 7

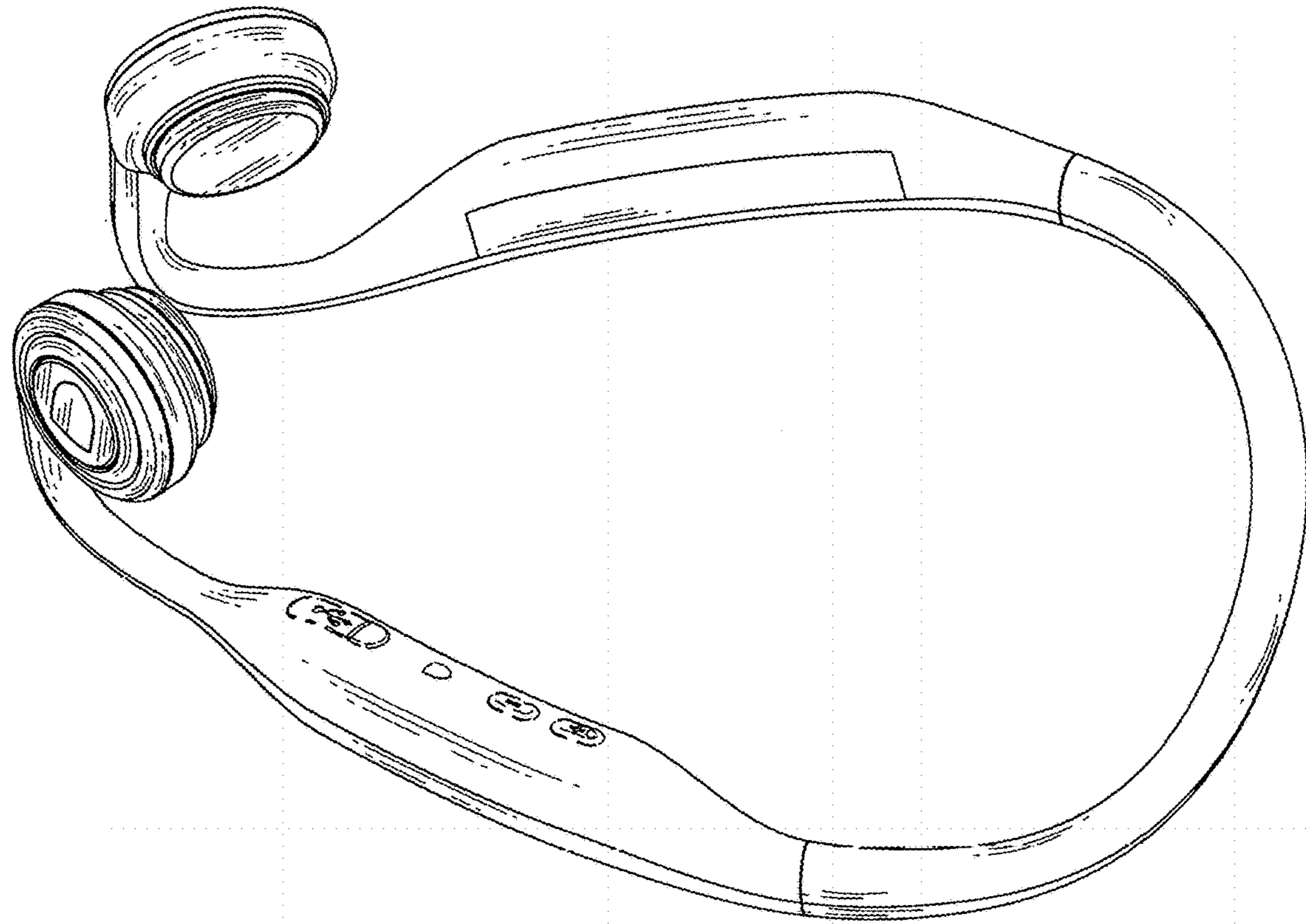


FIG. 8